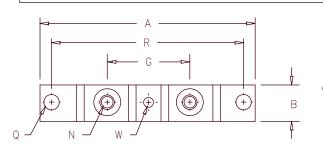
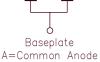
Schottky PowerMod













Notes: Baseplate: Nickel plated copper

Dim. Ir	nches	Millimeters		
Min.	Max.	Min.	Max.	Notes
B 0.700 C E 0.120 F 0.490 G 1.375 H 0.010 N Q 0.275 R 3.15	0.680 0.130 0.510 BSC 0.290 0 BSC	12.45 34.92 0.25 6.99 80.0	17.28 3.30 12.95 2 BSC 7.37	1/4-20 Dia.
U 0.600 V 0.312 W 0.180	0.340 0.195	15.24 7.92 4.57	8.64 4.95	Dia.

		Working Peak Reverse Voltage	
CPT50060*	MBR50060CT	60V	60V

*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard Rina Protection
- 500 Amperes/60 Volts
- 175°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

|F(AV) 500 Amps Average forward current per pkg Average forward current per leg F(AV) 250 Amps FSM 5000 Amps Maximum surge current per leg Maximum repetitive reverse current per leg ^IR(OV) 2 Amps Max peak forward voltage per lea VFM 0.73 Volt 0.73 Volts Max peak forward voltage per leg V_{FM} Max peak forward voltage per leg 0.58 Volts ^IRM Max peak reverse current per leg 200 mA ^IRM Max peak reverse current per leg 8.0 mA $V_R = 5.0V, T_C = 25^{\circ}C$ Typical junction capacitance 8800 pF

 ^{T}C = 132°C, Square wave, $^{R}\Theta JC$ = 0.12°C/W ^{T}C = 132°C, Square wave, $^{R}\Theta JC$ = 0.24°C/W 8.3ms, half sine, ^{T}J = 175°C f = 1 KHZ, 25°C, 1µsec square wave |FM = 250A: TJ = 25°C |FM = 250A: TJ = 175°C $VRRM, TJ = 125^{\circ}C^{*}$ $VRRM, TJ = 25^{\circ}C$

*Pulse test: Pulse width 300 \u03cmsec, Duty cycle 2%

Thermal and Mechanical Characteristics

TSTG Storage temp range ΤJ Operating junction temp range R OJC Max thermal resistance per leg ROJC Max thermal resistance per pkg Recs Typical thermal resistance (greased) Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) center hole must be torqued first Weight

-55℃ to 175℃ -55°C to 175°C 0.24°C/W Junction to case 0.12°C/W Junction to case 0.08°C/W Case to sink 35-40 inch pounds 30-40 inch pounds 8-10 inch pounds

2.8 ounces (78 grams) typical



CPT50060

Figure 1 Typical Forward Characteristics — Per Leg

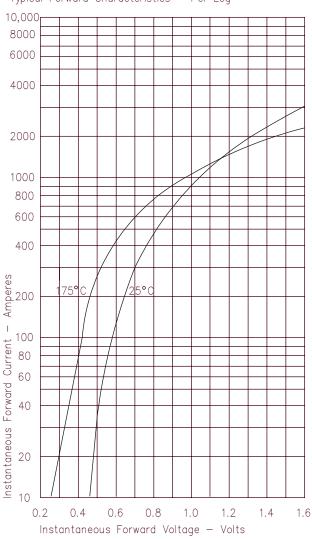


Figure 3 Typical Junction Capacitance — Per Leg 60,000 40,000 20,000 Junction Capacitance 10,000 6000 4000 2000 1000 0.1 0.5 1.0 5.0 10 50 100 Reverse Voltage - Volts

Figure 4

Forward Current Derating — Per Leg

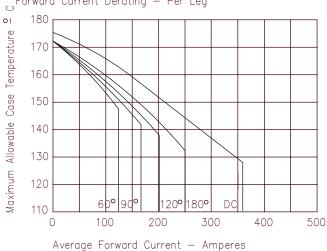


Figure 2 Typical Reverse Characteristics — Per Leg

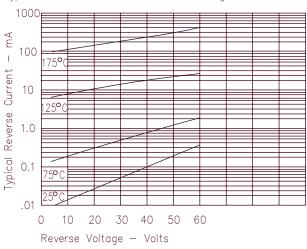


Figure 5
Maximum Forward Power Dissipation — Per Leg





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